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March 2013

FSUSB46 — Hi-Speed USB2.0 (480Mbps) DPST Switch with Dedicated Charger Port Detection

Features

- Low On Capacitance: 7.0pF Typical
- Low On Resistance: 3.90 Typical
- Low Power Consumption: 1µA Maximum
 - 15µA Maximum I_{CCT} over an Expanded Voltage Range (V_{IN} =1.8V, V_{CC} =4.3V)
- Wide -3db Bandwidth: > 720MHz
- Packaged in Pb-free, 8-Lead MicroPak™ (1.6mm wide), US8 (3.1mm wide), and UMLP (1.4x1.4mm)
- 8kV ESD Rating, >16kV Power/GND ESD Rating
- Power-Off Protection on All Ports When V_{CC}=0V - D+/D- Pins Tolerate up to 5.25V

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

IMPORTANT NOTE:

For additional performance information, please contact analogswitch@fairchildsemi.com.

Description

The FSUSB46 is a bi-directional, low-power, Hi-Speed. USB2.0 switch. Configured as a double-pole, singlethrow switch (DPST) switch, it is optimized for switching a Hi-Speed (480Mbps) source.

The FSUSB46 is compatible with the requirements of USB2.0 and features an extremely low on capacitance (C_{ON}) of 3.9pF. The wide bandwidth of this device (720MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk also minimizes interference.

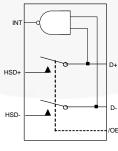
The FSUSB46 contains special circuitry on the switch I/O pins for applications where the V_{CC} supply is powered-off (V_{CC}=0), which allows the device to withstand an over-voltage condition. This device is designed to minimize current consumption even when the control voltage applied to the /OE pin is lower than the supply voltage (V_{CC}). This feature is especially valuable to ultra-portable applications, such as cell phones, allowing for direct interface with the generalpurpose I/Os of the baseband processor. An additional feature is the detection of the 1-1 (high/high) state on D+/D- to signal an interrupt (INT) to the processor when entering a dedicated charging port mode of operation.

Ordering In	Ordering Information							
Part Number	Operating Temperature Range	Package	Eco Status					
FSUSB46L8X	-40 to +85°C	8-Lead MicroPak™ 1.6mm Wide	RoHS					
FSUSB46K8X	-40 to +85°C	8-Lead US8, JEDEC MO187, Variation CA 3.1mm	Green					
FSUSB46UMX	-40 to +85°C	8-Lead Ultrathin Molded Leadless Package (UMLP), 1.2 x 1.4mm	Green					

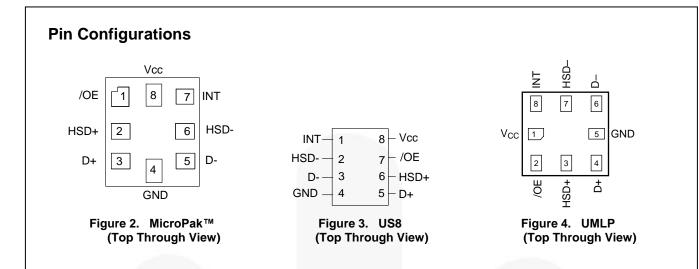
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W For Fairchild's definition of Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs_green.html</u>.

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Pin Definitions

Pin Name	Description
INT	Interrupt Signaling Output Pin
/OE	Switch Enable
D+, D-	USB Data Bus Connector
HSD+, HSD-	USB Source Inputs
GND	Ground
V _{cc}	Supply Voltage

Truth Table

Dat	a Path	Charger D	etect Path
/OE Switch Connection		D+ D-	INT Output
HIGH	D+, D- = Open	1-1	LOW
LOW	D+, D- = HSD+, HSD-	0X, X0	HIGH

FSUSB46 — Hi-Speed USB2.0 (480Mbps) DPST Switch with Dedicated Charger Port Detection

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
V _{CC}	Supply Voltage		-0.5	+5.5	V
V _{CNTRL}	DC Input Voltage (S) ⁽¹⁾		-0.5	V _{CC}	V
V _{SW}	DC Switch I/O Voltage ⁽¹⁾		-0.50	5.25	V
I _{IK}	DC Input Diode Current		-50		mA
I _{OUT}	DC Output Current			50	mA
T _{STG}	Storage Temperature		-65	+150	°C
		All Pins		7	
ESD	Human Body Model, JEDEC: JESD22-A114	I/O to GND		8	kV
230		Power to GND		16	κV
	Charged Device Model, JEDEC: JESD22-C10	01		2	

Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{cc}	Supply Voltage	3.0	4.3	V
V _{CNTRL}	Control Input Voltage (/OE) ⁽²⁾	0	V _{cc}	V
V _{sw}	Switch I/O Voltage	-0.5	V _{cc}	V
T _A	Operating Temperature	-40	+85	°C

Note:

2. The control input must be held HIGH or LOW; it must not float.

DC Electrical Characteristics

All typical value are at 25°C, V_{CC} =3.3V unless otherwise specified.

Cumula al	Demonstern	Canalitiana		T _A =- 40°C to +85°C			11
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Units
V _{IK}	Clamp Diode Voltage	I _{IN} =-18mA	3.0			-1.2	V
V _{IH}	Input Voltage High		3.0 to 3.6	1.3			V
VIH	input voltage riigh		4.3	1.7			V
V	Input Voltage Low		3.0 to 3.6			0.5	V
V _{IL}	Input Voltage Low		4.3			0.7	V
M		1	3.0 to 3.6	2.4			
V _{OH}	Output Voltage High	I _{OH} =-2mA	4.3	2.4			V
	V _{OL} Output Voltage Low	ut Voltage Low I _{OL} =2mA	3.0 to 3.6			0.25	V
V _{OL}			4.3			0.25	
I _{IN}	Control Input Leakage	V_{SW} =0 to V_{CC}	4.3	-1		1	μA
I _{oz}	Off State Leakage	HSD+ or HSD-=0V, 3.6V or floating	4.3	-2		2	μA
I _{OFF}	Power-Off Leakage Current (All I/O Ports)	V_{SW} =0V to 4.3V, V_{CC} =0V Figure 6	0	-2		2	μA
R _{ON}	HS Switch On Resistance ⁽³⁾	V _{SW} =0.4V, I _{ON} =-8mA Figure 5	3.0		3.9	6.5	Ω
ΔR_{ON}	HS Delta R _{ON} ⁽⁴⁾	V _{SW} =0.4V, I _{ON} =-8mA	3.0		0.65		Ω
I _{cc}	Quiescent Supply Current	V_{CNTRL} =0 or V_{CC} , I_{OUT} =0	4.3			1	μA
1	Increase in I _{cc} Current Per	V _{CNTRL} =2.6V V _{CC} =4.3V	4.3			10	μA
I _{CCT}	Control Voltage and V _{CC}	V _{CNTRL} =1.8V V _{CC} =4.3V	4.3			20	μA

Notes:

3. Measured by the voltage drop between HSDn and Dn pins at the indicated current through the switch.

On resistance is determined by the lower of the voltage on the two (HSDn or Dn ports).

4. Guaranteed by characterization.

	Devenuetor	Conditions		T _A =- 40°C to +85°C			11.24
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Units
t _{on}	Turn-On Time /OE to Output	R_L =50 Ω , C_L =5pF V _{SW} =0.8V Figure 7, Figure 8	3.0 to 3.6		13	30	ns
t _{OFF}	Turn-Off Time /OE to Output	R_L =50 Ω , C_L =5pF V _{SW=} 0.8V Figure 7, Figure 8	3.0 to 3.6		12	25	ns
t _{PD}	Propagation Delay ⁽⁵⁾	$C_L=5 \text{ pF}, R_L=50\Omega$ Figure 7, Figure 9	3.3		0.25		ns
t _{BBM}	Break-Before-Make	R_L =50 Ω , C_L =5pF V_{SW1} = V_{SW2} =0.8V Figure 13	3.0 to 3.6	2.0		6.5	ns
t _{PLH/HL}	INT Propagation Delay ⁽⁵⁾	R _L =500Ω, C _L =5pF	3.0 to 3.6		10		ns
O _{IRR}	Off Isolation	R _L =50Ω, f=240MHz Figure 15	3.0 to 3.6		-30		dB
Xtalk	Non-Adjacent Channel Crosstalk	R _L =50Ω, f=240MHz Figure 16	3.0 to 3.6		-45		dB
BW	-3db Bandwidth	$R_L=50\Omega$, $C_L=0pF$ Figure 14	- 3.0 to 3.6		720		MHz
DVV		$R_L=50\Omega$, $C_L=5pF$ Figure 14	3.0 10 3.0		550		MHz

Note:

5. Guaranteed by characterization.

AC Electrical Characteristics

USB Hi-Speed-Related AC Electrical Characteristics

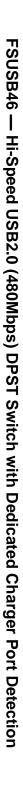
Symbol	Deremeter	Conditions	V _{cc} (V)	T _A =- 40°C to +85°C			Linite
Symbol	Parameter	Conditions		Min.	Тур.	Max.	Units
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁶⁾	$C_L=5pF, R_L=50\Omega$ Figure 10	3.0 to 3.6		20		ps
tj	Total Jitter ⁽⁶⁾	R _L =50Ω, C _L =5pf, t _R =t _F =500ps (10-90%) at 480Mbps (PRBS=2 ¹⁵ – 1)	3.0 to 3.6		200		ps

Note:

6. Guaranteed by characterization.

Capacitance

Symbol	Deremeter	Conditions	T _A =- 40°C to +85°C			L Inite
	Parameter	Conditions	Min.	Тур.	Max.	Units
C _{IN}	Control Pin Input Capacitance	V _{CC} =0V		1.5		pF
C _{OUT}	INT Pin Output Capacitance	V _{CC} =0V		2.5		pF
C _{ON}	D+, D- On Capacitance	V _{CC} =3.3V, f=1MHz Figure 12		7.0	7.9	pF
C_{OFF}	D+, D- Off Capacitance	V _{CC} =3.3V Figure 11		2.0		pF



D+, D-

 $t_{FALL} = 2.5 ns$

10%

90%

 $t_{FALL} = 500 ps$

10%

/OE

 $V_{/O}$ =0 or V_{CC}

Vsw

Α

0 or Vcc

909

90%

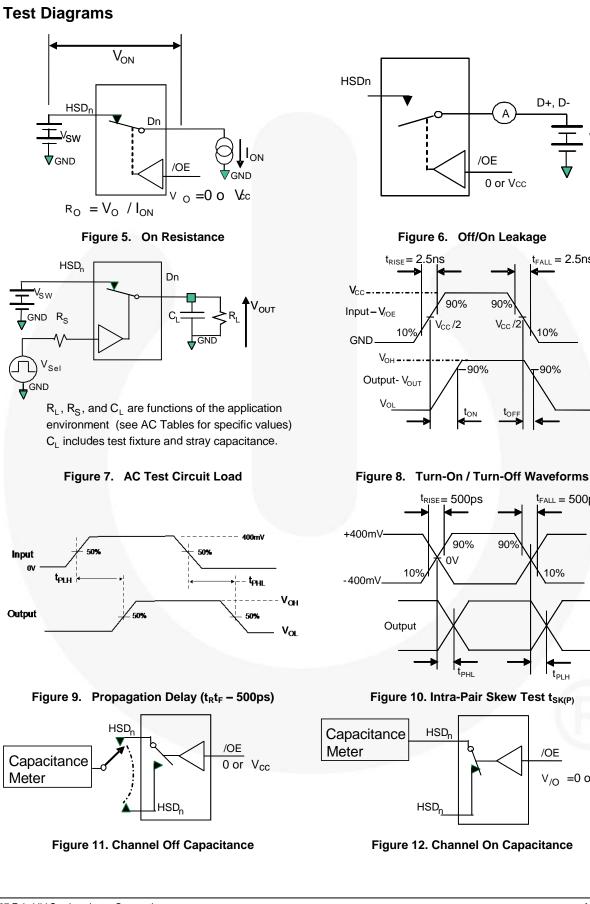
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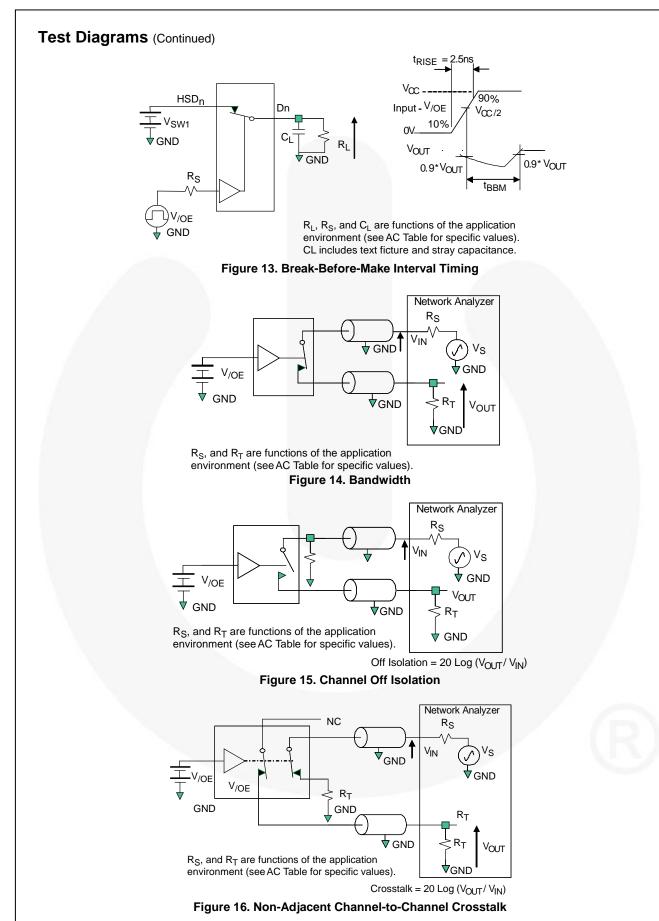
Vcc/2

to

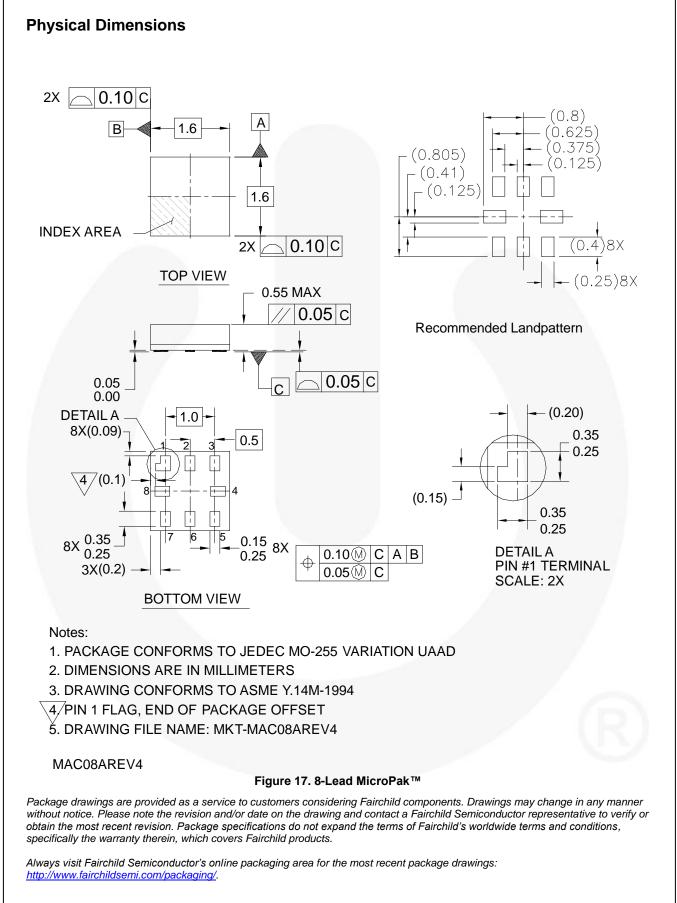
90%

/OE





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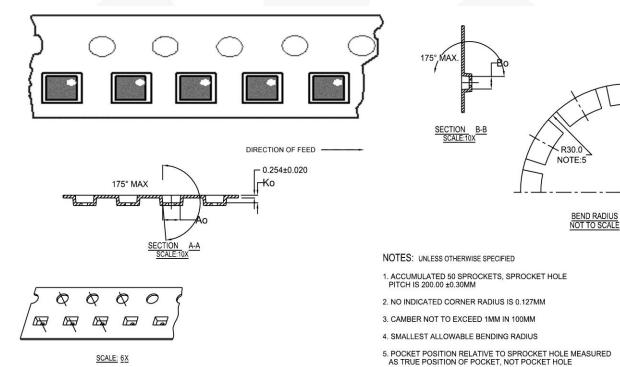


Tape and Reel Specifications							
Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Tape Status			
	Leader (Start End)	125 (Typical)	Empty	Sealed			
L6X, L8X, L10X	Carrier	5000	Filled	Sealed			
	Trailer (Hub End)	75 (Typical)	Empty	Sealed			

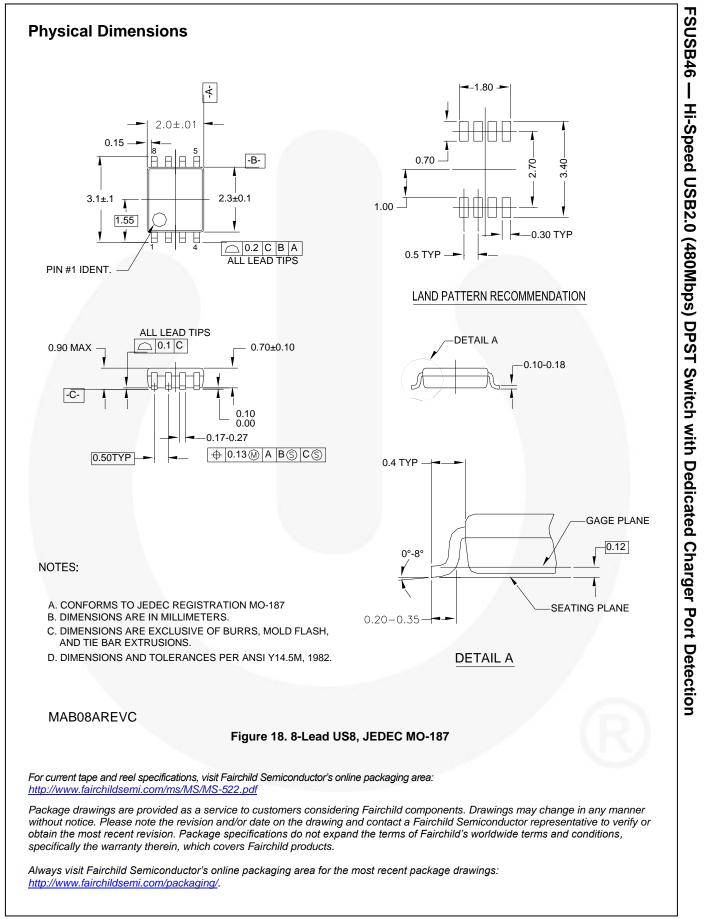
Standard Tape and Reel Specifications

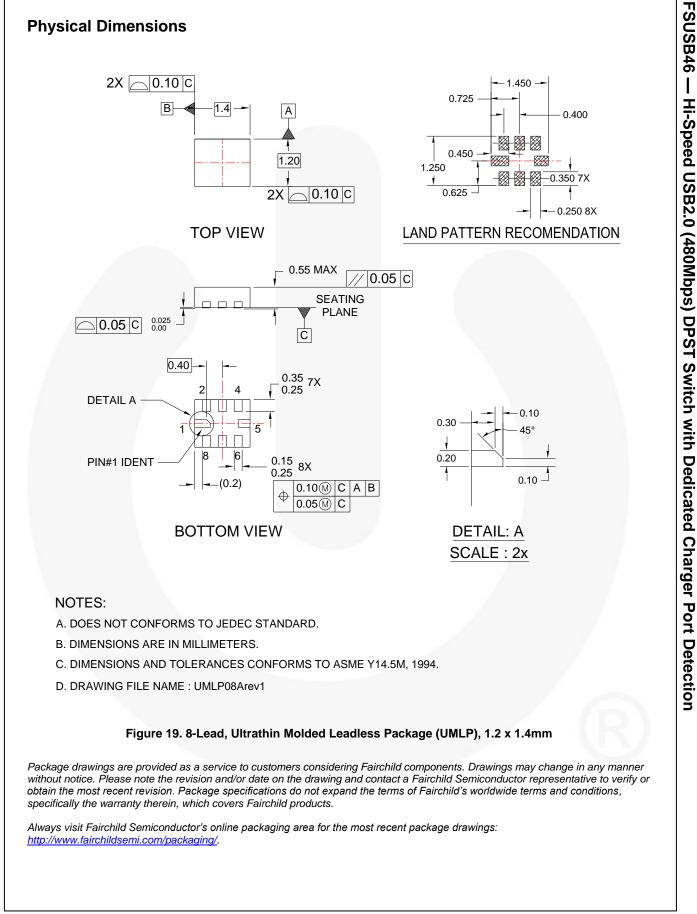
Standard tape and reel specifications for MicroPak are available at Fairchild Semiconductor's website: <u>http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf</u>

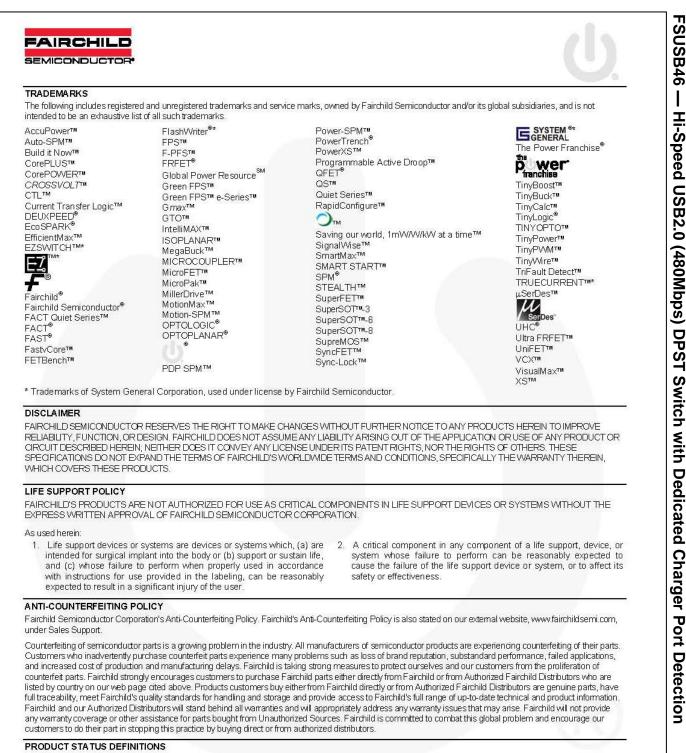
FSUSB46L8X_F130 Tape and Reel Specifications



10	30056	2.30 ± 0.1mm	1.78 ± 0.1mm	0.68 ± 0.1mm
8	30038	1.78 ± 0.1mm	1.78 ± 0.1mm	0.68 ± 0.1mm
6	30033	1.60 ± 0.1mm	1.15 ± 0.1mm	0.70 ± 0.1mm







Definition of Terms Datasheet Identification

Advance Information

No Identification Needed

Preliminary

Ohsolete

Product Status

First Production

Full Production

Not In Production

Formative / In Design

Rev. 144

at any time without notice to improve the design

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